



BCP55T series

60 V, 1 A NPN medium power transistors

Rev. 1 — 29 April 2019

Product data sheet

1. Product profile

1.1. General description

NPN medium power transistors in a medium power SOT223 (SC73) Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

| Type number | Package | | NPN complement |
|-------------|----------|-------|----------------|
| | Nexperia | JEDEC | |
| BCP55T | SOT223 | SC-73 | BCP52T |
| BCP55-10T | | | BCP52-10T |
| BCP55-16T | | | BCP52-16T |

1.2. Features and benefits

- High collector current capability I_C and I_{CM}
- Three current gain selections
- High power dissipation capability
- AEC-Q101 qualified

1.3. Applications

- Linear voltage regulators
- MOSFET drivers
- High-side switches
- Power management
- Amplifiers

1.4. Quick reference data

Table 2. Quick reference data

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

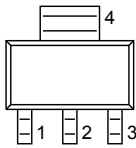
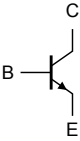
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------|---------------------------|--------------------------------------|-----|-----|-----|------|
| V_{CEO} | collector-emitter voltage | open base | - | - | 60 | V |
| I_C | collector current | | - | - | 1 | A |
| I_{CM} | peak collector current | single pulse; $t_p \leq 1\text{ ms}$ | - | - | 2 | A |

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|-----------|-----------------|--|-----|-----|-----|------|--|
| h_{FE} | DC current gain | | | | | | |
| | BCP55T | $V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}$ | [1] | 63 | - | 250 | |
| | BCP55-10T | | [1] | 63 | - | 160 | |
| BCP55-16T | [1] | | 100 | - | 250 | | |

[1] pulsed; $t_p \leq 300 \mu\text{s}$; $\delta \leq 0.02$

2. Pinning information

Table 3. Pinning

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--|---|
| 1 | B | base |  |  sym123 |
| 2 | C | collector | | |
| 3 | E | emitter | | |
| 4 | C | collector | | |

3. Ordering information

Table 4. Ordering information

| Type number | Package | | Version |
|-------------|---------|--|---------|
| | Name | Description | |
| BCP55T | SC-73 | plastic, surface-mounted package with increased heatsink; 4 leads | SOT223 |
| BCP55-10T | | | |
| BCP55-16T | | | |

4. Marking

Table 5. Marking

| Type number | Marking code |
|-------------|--------------|
| BCP55T | BCP55T |
| BCP55-10T | P5510T |
| BCP55-16T | P5516T |

5. Limiting values

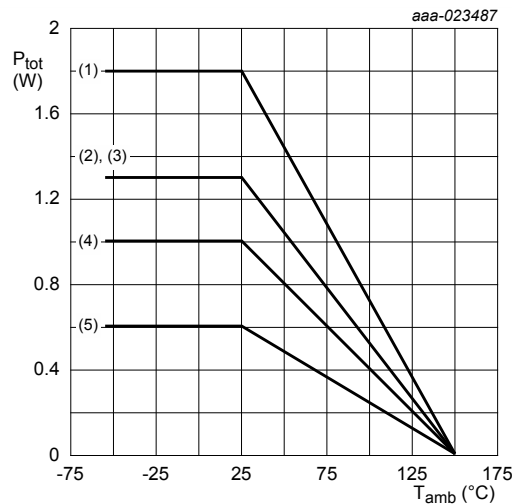
Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

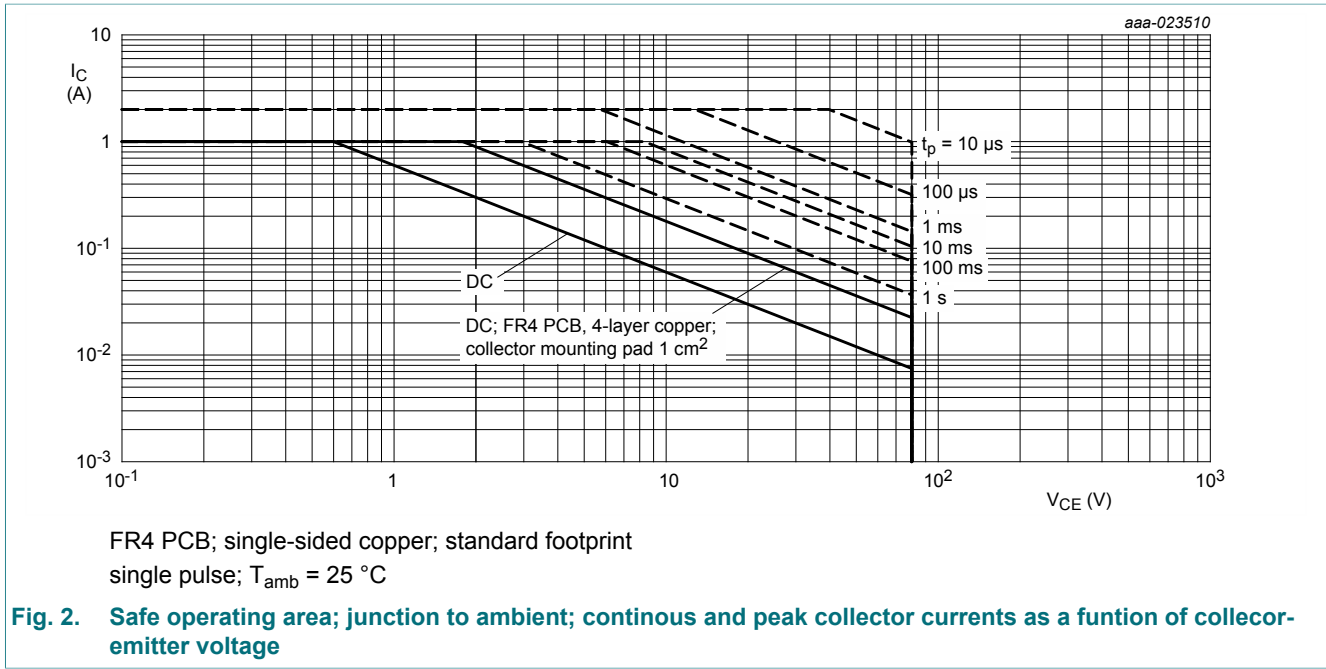
| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|---------------------------|--------------------------------------|-----|-----|------|
| V_{CBO} | collector-base voltage | open emitter | - | 60 | V |
| V_{CEO} | collector-emitter voltage | open base | - | 60 | V |
| V_{EBO} | emitter-base voltage | open collector | - | 5 | V |
| I_C | collector current | | - | 1 | A |
| I_{CM} | peak collector current | single pulse; $t_p \leq 1\text{ ms}$ | - | 2 | A |
| I_B | base current | | - | 0.2 | A |
| I_{BM} | peak base current | single pulse; $t_p \leq 1\text{ ms}$ | - | 0.3 | A |
| P_{tot} | total power dissipation | $T_{amb} \leq 25\text{ °C}$ | [1] | 0.6 | W |
| | | | [2] | 1 | W |
| | | | [3] | 1.3 | W |
| | | | [4] | 1.3 | W |
| | | | [5] | 1.8 | W |
| T_j | junction temperature | | - | 150 | °C |
| T_{amb} | ambient temperature | | -55 | 150 | °C |
| T_{stg} | storage temperature | | -65 | 150 | °C |

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 1 cm^2 .
- [3] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 6 cm^2 .
- [4] Device mounted on an FR4 Printed-Circuit-Board (PCB); 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 Printed-Circuit-Board (PCB); 4-layer copper; tin-plated; mounting pad for collector 1 cm^2 .



- (1) FR4 PCB; 4-layer copper; 1 cm^2
- (2) FR4 PCB; single-sided copper; 6 cm^2
- (3) FR4 PCB; 4-layer copper; standard footprint
- (4) FR4 PCB; single-sided copper; 1 cm^2
- (5) FR4 PCB; single-sided copper; standard footprint

Fig. 1. Power derating curves



6. Thermal characteristics

Table 7. Thermal characteristics

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---------------|--|-------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | - | 209 | K/W |
| | | | [2] | | | 125 | K/W |
| | | | [3] | | | 97 | K/W |
| | | | [4] | - | - | 97 | K/W |
| | | | [5] | - | - | 70 | K/W |
| $R_{(j-sp)}$ | thermal resistance from junction to solder point | | | - | - | 18 | K/W |

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 1 cm².
- [3] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 6 cm².
- [4] Device mounted on an FR4 Printed-Circuit-Board (PCB); 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 Printed-Circuit-Board (PCB); 4-layer copper; tin-plated; mounting pad for collector 1 cm².

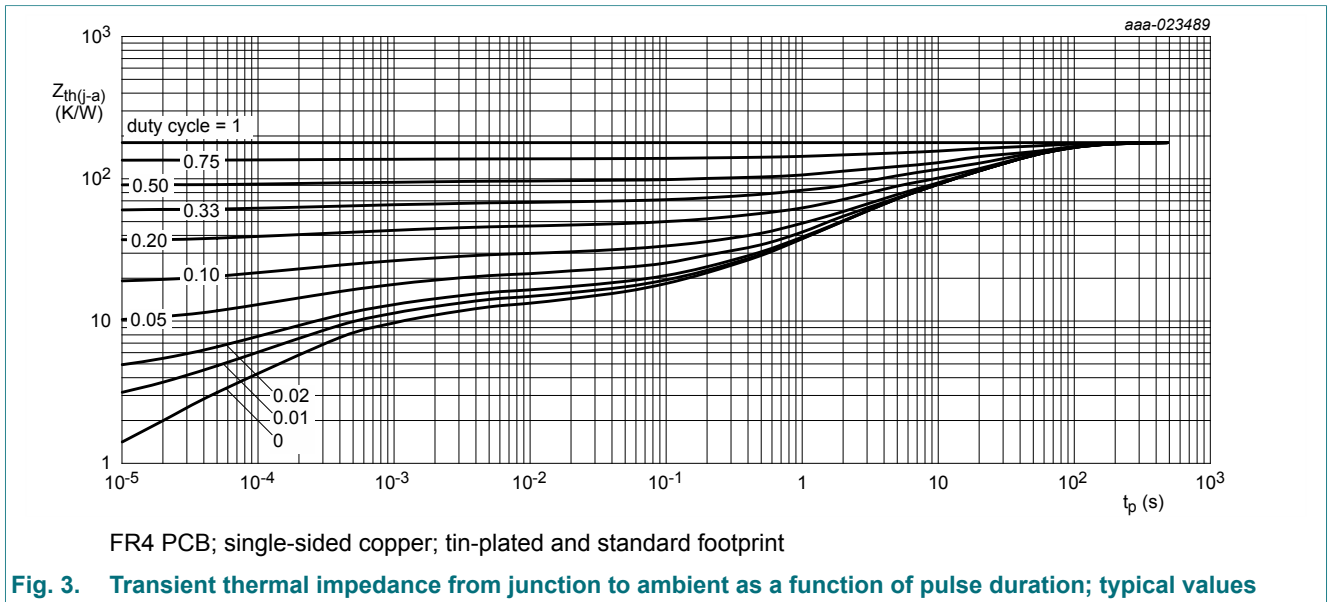
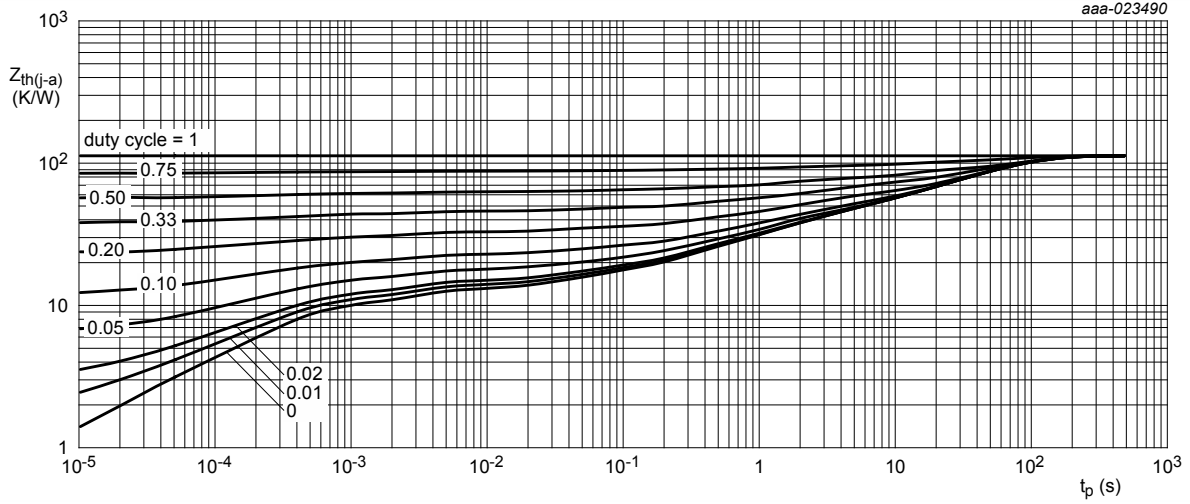
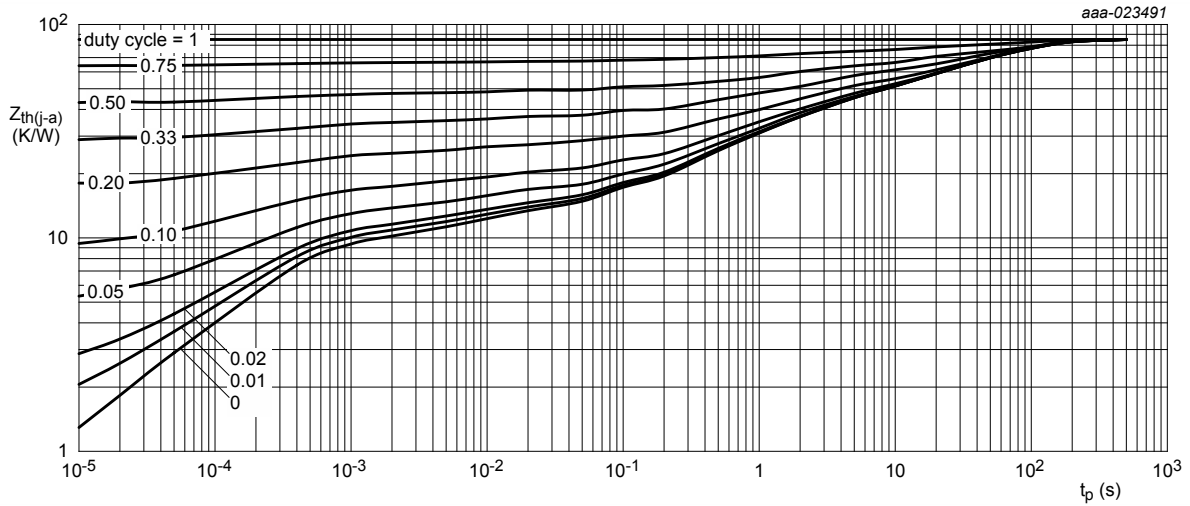


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



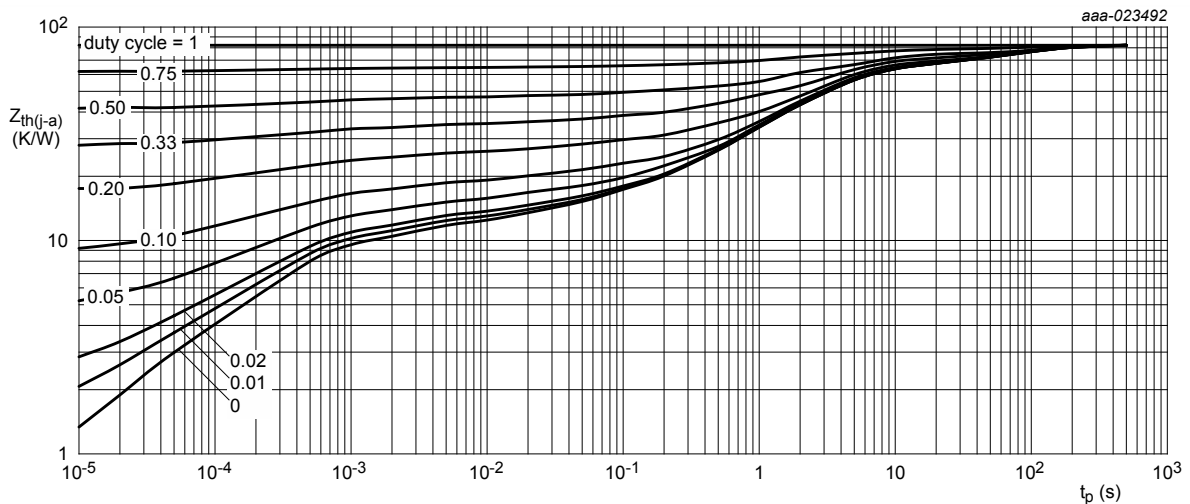
FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm²

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



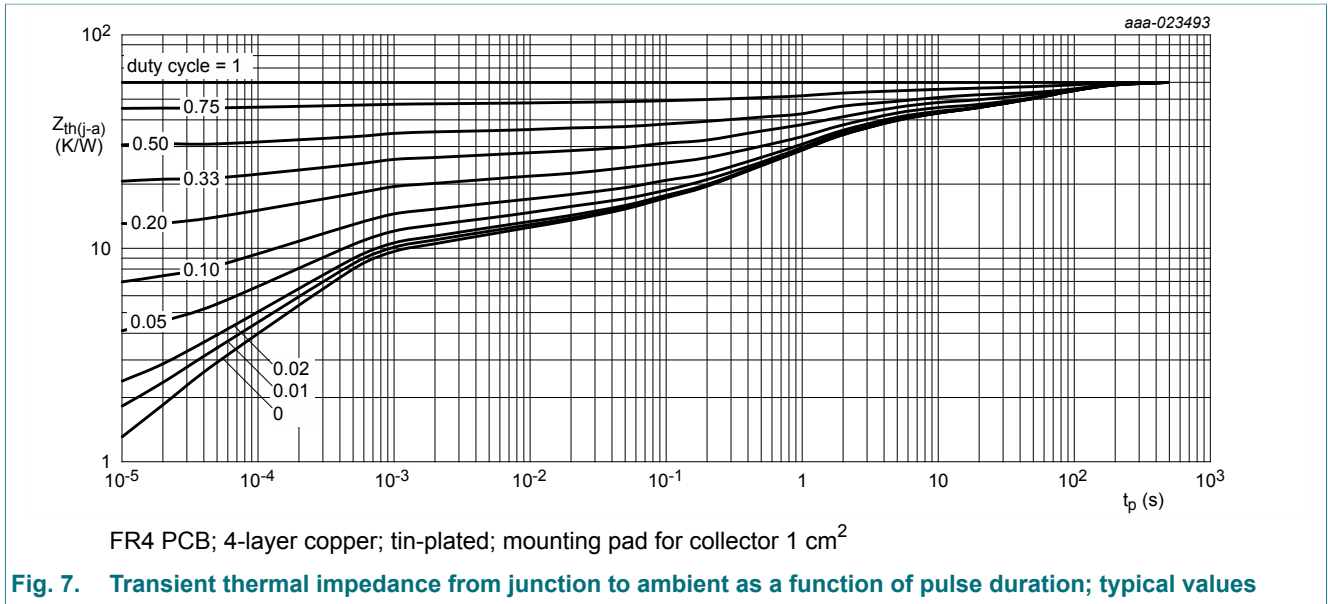
FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm²

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB; 4-layer copper; tin-plated and standard footprint

Fig. 6. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



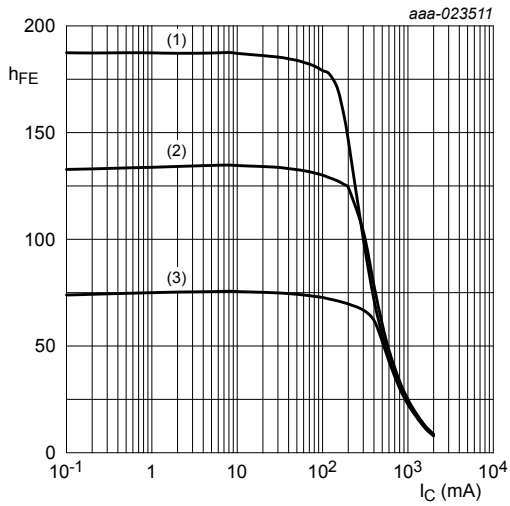
7. Characteristics

Table 8. Characteristics

T_{amb} = 25 °C unless otherwise specified.

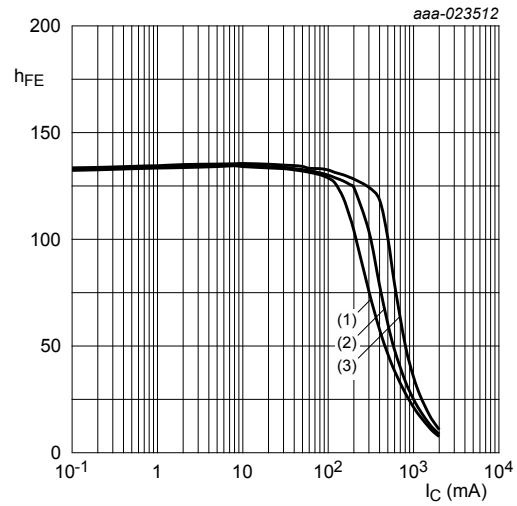
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------------------|--|--|-----|-----|-----|------|
| V _{(BR)CBO} | collector-base breakdown voltage | I _C = 100 μA; I _E = 0 A | 60 | - | - | V |
| V _{(BR)CEO} | collector-emitter breakdown voltage | I _C = 2 mA; I _E = 0 A | 60 | - | - | V |
| V _{(BR)EBO} | emitter-base breakdown voltage | I _E = 100 μA; I _C = 0 A | 5 | - | - | V |
| I _{CBO} | collector-base cut-off current | V _{CB} = 30 V; I _E = 0 A | - | - | 100 | nA |
| | | V _{CB} = 30 V; I _E = 0 A; T _J = 150 °C | - | - | 10 | μA |
| I _{EBO} | emitter-base cut-off current | V _{EB} = 5 V; I _C = 0 A | - | - | 100 | nA |
| h _{FE} | DC current gain | | | | | |
| | BCP55T, -10T, -16T | V _{CE} = 2 V; I _C = 5 mA | 63 | - | - | |
| | | V _{CE} = 2 V; I _C = 500 mA | [1] | 40 | - | - |
| | BCP55T | V _{CE} = 2 V; I _C = 150 mA | [1] | 63 | - | 250 |
| | BCP55-10T | V _{CE} = 2 V; I _C = 150 mA | [1] | 63 | - | 160 |
| BCP55-16T | V _{CE} = 2 V; I _C = 150 mA | [1] | 100 | - | 250 | |
| V _{CEsat} | collector-emitter saturation voltage | I _C = 500 mA; I _B = 50 mA | [1] | - | 500 | mV |
| V _{BE} | base-emitter voltage | V _{CE} = 2 V; I _C = 500 mA | [1] | - | 1 | V |
| f _T | transition frequency | V _{CE} = 5 V; I _C = 50 mA; f = 100 MHz | 100 | 155 | - | MHz |
| C _c | collector capacitance | V _{CB} = 10 V; I _E = i _e = 0 A; f = 1 MHz | - | 4.5 | - | pF |

[1] pulsed; t_p ≤ 300 μs; δ ≤ 0.02



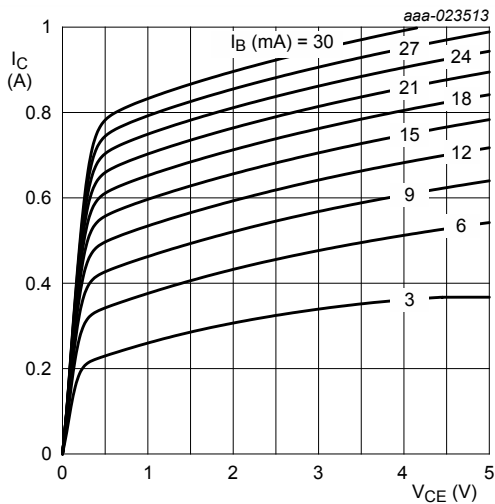
$V_{CE} = 2\text{ V}$
 (1) $T_{amb} = 100\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = -55\text{ }^\circ\text{C}$

Fig. 8. DC current gain as a function of collector current; typical values



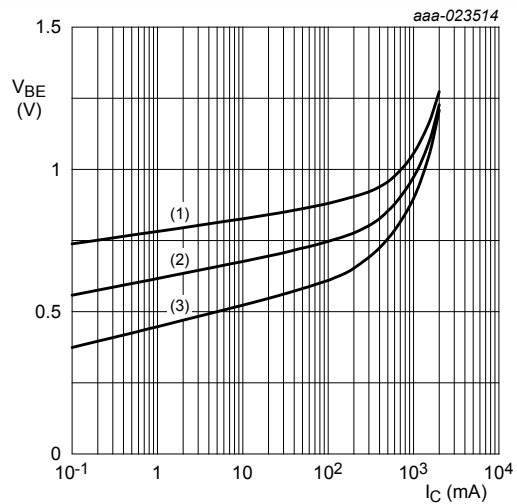
$T_{amb} = 25\text{ }^\circ\text{C}$
 (1) $V_{CE} = 1\text{ V}$
 (2) $V_{CE} = 2\text{ V}$
 (3) $V_{CE} = 5\text{ V}$

Fig. 9. DC current gain as a function of collector current; typical values



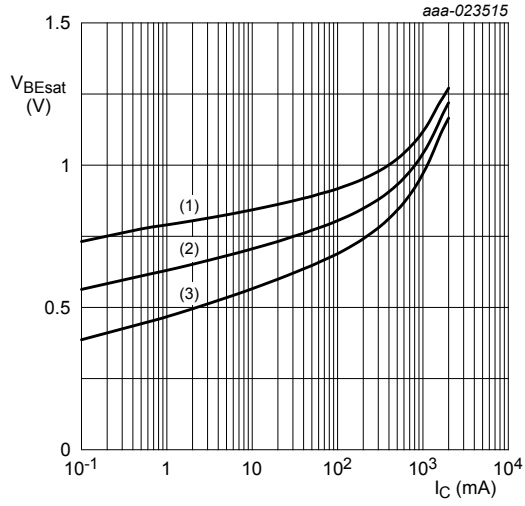
$T_{amb} = 25\text{ }^\circ\text{C}$

Fig. 10. Collector current as a function of collector-emitter voltage; typical values



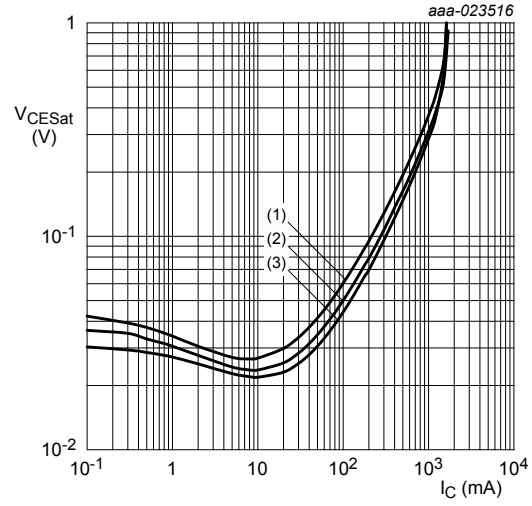
$V_{CE} = 2\text{ V}$
 (1) $T_{amb} = -55\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = 100\text{ }^\circ\text{C}$

Fig. 11. Base-emitter voltage as a function of collector current; typical values



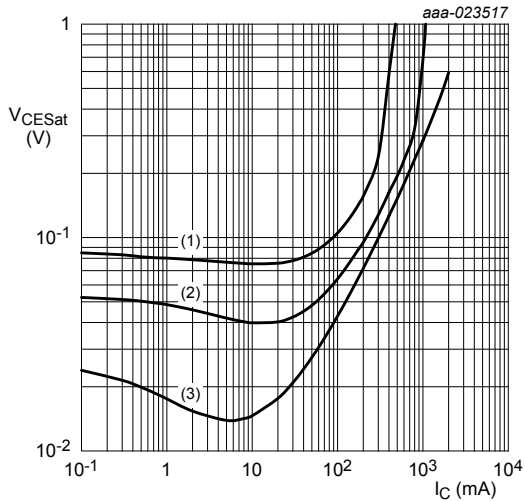
$I_C/I_B = 10$
 (1) $T_{amb} = -55\text{ °C}$
 (2) $T_{amb} = 25\text{ °C}$
 (3) $T_{amb} = 100\text{ °C}$

Fig. 12. Base-emitter saturation voltage as a function of collector current; typical values



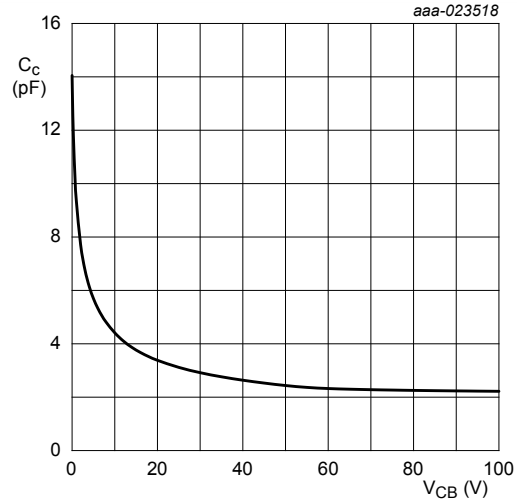
$I_C/I_B = 10$
 (1) $T_{amb} = 100\text{ °C}$
 (2) $T_{amb} = 25\text{ °C}$
 (3) $T_{amb} = -55\text{ °C}$

Fig. 13. Collector-emitter saturation voltage as a function of collector current; typical values



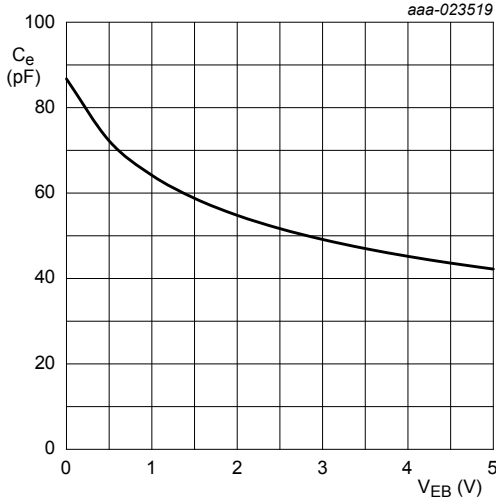
$T_{amb} = 25\text{ °C}$
 (1) $I_C/I_B = 50$
 (2) $I_C/I_B = 20$
 (3) $I_C/I_B = 5$

Fig. 14. Collector-emitter saturation voltage as a function of collector current; typical values



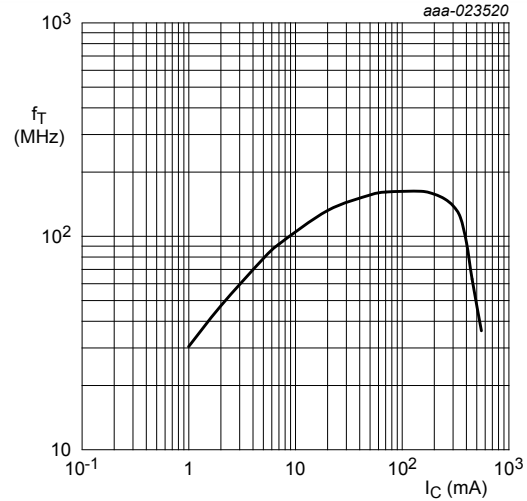
$f = 1\text{ MHz}; T_{amb} = 25\text{ °C}$

Fig. 15. Collector capacitance as a function of collector-base voltage; typical values



$f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$

Fig. 16. Emitter capacitance as a function of emitter-base voltage; typical values



$V_{CE} = 5 \text{ V}$

$f = 100 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$

Fig. 17. Transition frequency as a function of collector current; typical values

8. Test information

8.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

9. Package outline

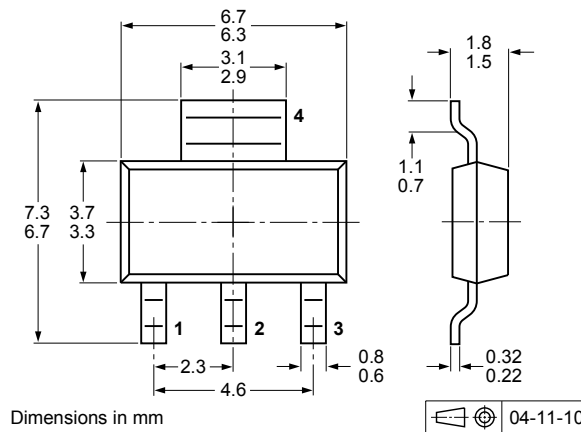
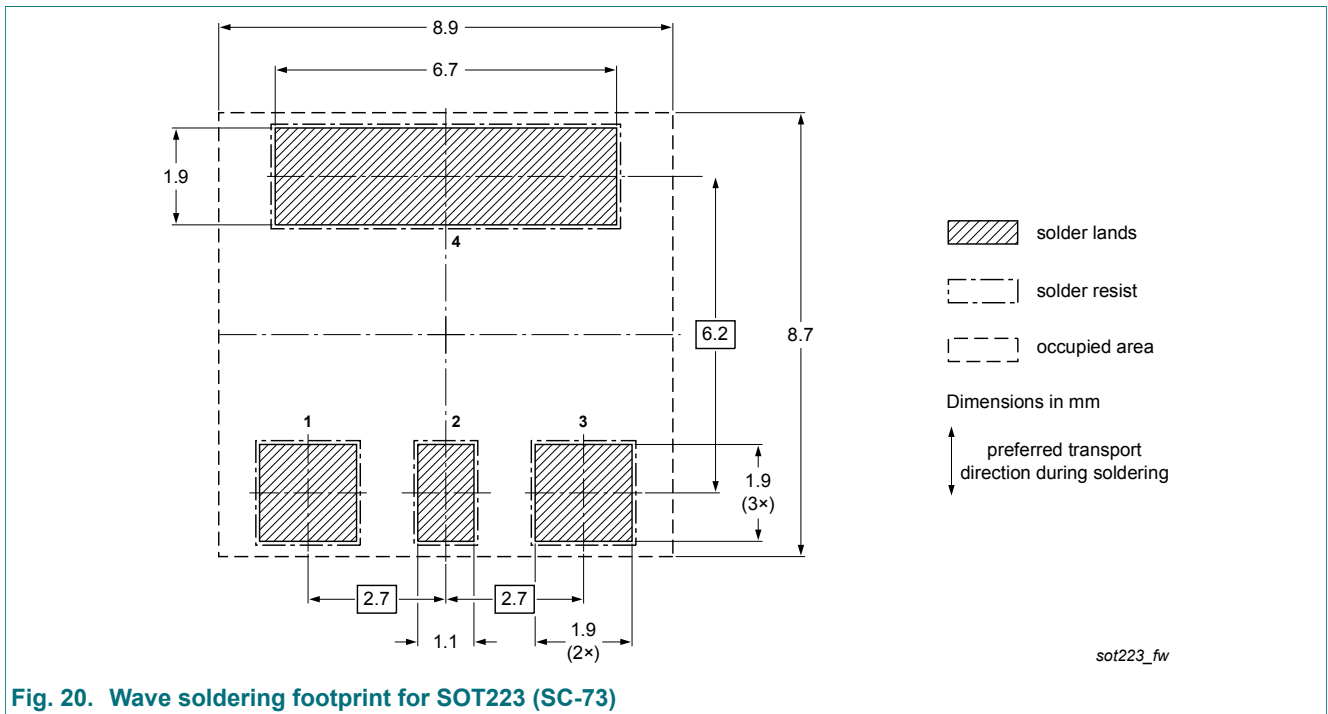
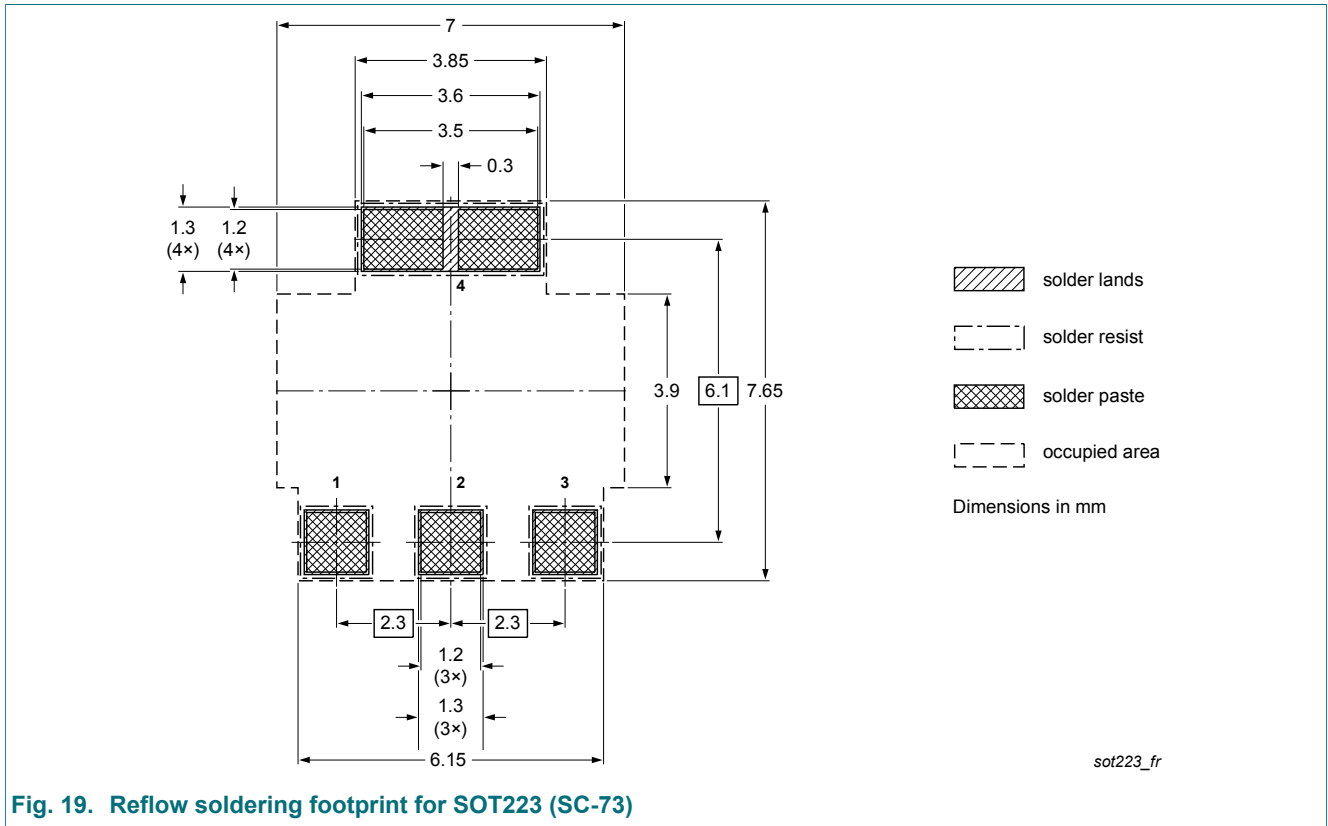


Fig. 18. Package outline SOT223 (SC-73)

10. Soldering



11. Revision history

Table 9. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--------------|--------------------|---------------|------------|
| BCP55T_SER v.1 | 20190429 | Product data sheet | - | - |

12. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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